

STRUCTURE

Silicon Monolithic Integrated Circuit

PRODUCT NAME

γ-correction IC for TFT-LCD Panel

TYPE

BD8138EFV

FEATURES

Built-in 10ch γ-correction + Vcom outputs
 1²C Bus Interface Control (slave mode)

○ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

ADSOLUTE MAXIMUM HATTNOS (Ta=25 C)				
PARAMETER	SYMBOL	LIMITS	UNIT	
Power Supply Voltage 1	DVCC 7		V	
Power Supply Voltage 2	VCC	20	٧	
REFIN Voltage	REF	20	٧	
Amplifier Drive Current	lo	50*1	mA	
Junction Temperature	Tjmax	150	Ĉ	
Power Dissipation	Pd	1600*2	mW	
Operating Temperature Range	Topr	-30~+85	C	
Storage Temperature Range	Tstg	-55∼+150	°C	

^{*1} Do not however exceed Pd, ASO and Tjmax=150°C.

OPERATING CONDITION (Ta=25℃)

PARAMETER	SYMBOL	MIN	MAX	UNIT
Power Supply Voltage 1	DVCC	2.3	4.0	٧
Power Supply Voltage 2	VCC	6	18	٧
REFIN Voltage	REF	6	18	V
Amplifier Drive Current	lo		40	mA
I ² C Bus Frequency	fCLK	_	400	KHZ
OSC Frequency	fosc	10	200	KHz

^{*}The product described in this specification is a strategic product (and/or service) subject to COCOM regulations. It should not be exported without authorization from the appropriate government.

The Japanese version of this document is the formal specification.

A customer may use this translation version only for a reference to help reading the formal version. If there are any differences in translation version of this document, formal version takes priority.

^{*2} Pd decreased at 12.8mV/°C for temperatures above Ta=25°C, mounted on 70×70×1.6mm Glass-epoxy PCB.

^{*}This product is not designed for normal operation within a radio active environment.

^{*}Status of this document

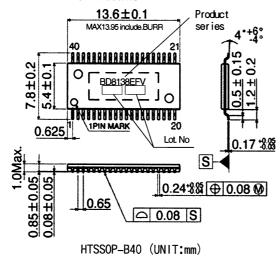


OELECTRICAL CHARACTERISTICS (Unless otherwise specified VCC=15V, DVCC=3.3V, Ta=25°C)

PARAMETER SYMBOL LIMIT UNIT CONDITIONS [REF IN] Sink Current IREF 25 50 75 μ A REF=10V [γ -CORRECTION AMP] Drive Current Io 150 300 - mA DAC=3V, OUTx=0V Load Regulation Δ V - 5 20 mV Io=+10mA \sim -10mA, OUTx=6V Output Voltage High VOH VCC-0.16 VCC-0.1 - V Io=-5mA Output Voltage Low VOL - 0.1 0.16 V Io=5mA [COMMON AMP] Input Bias Current Ib - 0 1 μ A VFB=6V Drive Current Io 150 300 - mA DAC=3V, OUTx=0V							
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(γ-CORRECTION AMP) Drive Current lo 150 300 - mA DAC=3V, OUTx=0V Load Regulation ΔV - 5 20 mV lo=+10mA ~ -10mA, OUTx=6V Output Voltage High VOH VCC-0.16 VCC-0.1 - V lo=-5mA Output Voltage Low VOL - 0.1 0.16 V lo=5mA COMMON AMP Input Bias Current Ib - 0 1 μA VFB=6V Drive Current lo 150 300 - mA DAC=3V, OUTx=0V							
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Drive Current Io 150 300 - mA DAC=3V, OUTx=0V							
10 100 000 III.							
lood Domilation AV F OO WAY							
	lo=+10mA ∼ −10mA, OUTx=3V						
Input Voltage Range VFB 0 - VDAC V Ro=100KΩ, Co=100pF	Ro=100KΩ, Co=100pF						
Output Voltage high VOH VCC-0.16 VCC-0.1 - V Io=-5mA							
Output voltage Low VOL - 0.1 0.16 V Io=5mA							
[DAC]							
Resolution Coding Res - 10 - Bit							
Non-Linear Error LE -2 - 2 LSB Range of OOA ~ 3F5 error with idea	straight						
Differential Error DLE -2 - 2 LSB Range of 00A ~ 3F5 error with ideal amount of Increas							
[OSC]	<u> </u>						
Frequency fosc - 95 - KHz Internal oscillator mode							
[CONTROL SIGNAL]							
Sink Current IctL - 16 25 uA							
SDA output voltage Low VSDA 0.4 V ISDA=3.0mA							
Input leakage Current ILi -10 - 10 μA 0.4V~0.9DVCC							
Threshold Voltage VTH 0.7 - 2.6 V DVCC=3.3V							
Reset Time trst - 45 - μ s CCT=1000pF							
[WHOLE DEVICE]							
Circuit Current Icc - 12 - mA All outputs = 5V							

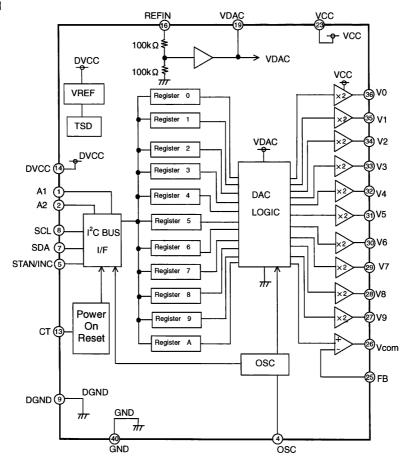
^{*}This product is not designed for protection against radioactive rays.

OPHYSICAL DIMENSIONS . MARKING





OBLOCK DIAGRAM



**Refer to the Technical Note about the details of the application.

OPIN No, Pin Name, Function

PIN No	PIN NAME	Function	PIN No	PIN NAME	Function
1	A1	Slave/Slave adress set① Autoread/word address set① for EEPROM	21	NC	_
2	A2	Slave/Slave adress set② Autoread/word address set② for EEPROM	22	NC	_
3	NC	_	23	VCC	POWER SUPPLY
4	88	SYNCHRONIZED CLOCK INPUT	24	NC	_
5	STAN/INC	INPUT MODE SWITCH FOR 12C	25	FB	COM negative feedback INPUT
6	NC	_	26	VCOM	COM OUTPUT
7	SDA	DATA SIGNAL INPUT FOR 12C	27	V9	GAMMA 9 output
8	SCL	CLOCK SIGNAL INPUT FOR 12C	28	V8	GAMMA 8 output
9	DGND	GROUND	29	V7	GAMMA 7 output
10	DACGND	GROUND FOR DAC	30	V6	GAMMA 6 output
11	NC	<u> </u>	31	V5	GAMMA 5 output
12	NC	<u> </u>	32	V4	GAMMA 4 output
13	СТ	CAPACITOR CONNECTION FOR POWER ON RESET	33	V3	GAMMA 3 output
14	DVCC	DIGITAL POWER SUPPLY	34	V2	GAMMA 2 output
15	NC		35	V1	GAMMA 1 output
16	REFIN	DAC REFERENCE INPUT	36	VO	GAMMA 0 output
17	NC	_	37	NC	_
18	NC	_	38	NC	_
19	VDAC	DAC VOLTAGE OUTPUT	39	NC	_
20	NC	-	40	GND	GROUND



Operation Notes

1) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings such as the applied voltage or operating temperature range may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure such as a fuse should be implemented when use of the IC in a special mode where the absolute maximum ratings may be exceeded is anticipated.

2) GND potential

Ensure a minimum GND pin potential in all operating conditions.

3) Setting of heat

Use a setting of heat that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

4) Pin short and mistake fitting

Use caution when orienting and positioning the IC for mounting on printed circuit boards. Improper mounting may result in damage to the IC. Use of the IC in excess of absolute maximum ratings such as the applied voltage or operating temperature range may result in IC damage.

5) Actions in strong magnetic field

Use caution when using the IC in the presence of a strong electromagnetic field as doing so may cause the IC to malfunction.

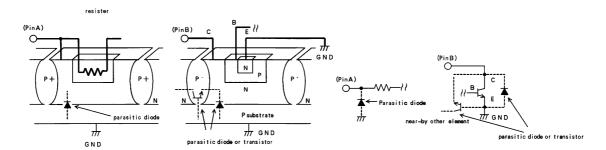
6) Ground wiring patterns

When using both small signal and large current GND patterns, it is recommended to isolate the two ground patterns, placing a single ground point at the application's reference point so that the pattern wiring resistance and voltage variations caused by large currents do not cause variations in the small signal ground voltage. Be careful not to change the GND wiring patterns of any external components.

7) Regarding input pin of the IC

This monolithic IC contains P⁺ isolation and P substrate layers between adjacent elements in order to keep them isolated. P/N junctions are formed at the intersection of these P layers with the N layers of other elements to create a variety of parasitic elements. For example, when a resistor and transistor are connected to pins. (see the chart below)

The formation of parasitic NPN transistors according to the relationships of different IC pins is an inevitable result of the IC's architecture. The operation of parasitic elements can cause interference with circuit operation as well as IC malfunction and damage. For these reasons, it is necessary to use caution so that the IC is not used in a way that will trigger the operation of parasitic elements, such as by the application of voltages lower than the GND (P substrate) voltage to input and out



8) Thermal shutdown circuit (TSD)

This IC incorporates a built-in thermal shutdown circuit for the protection from thermal destruction. The IC should be used within the specified power dissipation range. However, in the event that the IC continues to be operated in excess of its power dissipation limits, the attendant rise in the chip's temperature Tj will trigger the thermal shutdown circuit to turn off all output power elements. The circuit will automatically reset once the chip's temperature Tj drops. Operation of the thermal shutdown circuit presumes that the IC's absolute maximum ratings have been exceeded. Application designs should never make use of the circuit.

9) Testing on application boards

When testing the IC on an application board, connecting a capacitor to a pin with low impedance subjects the IC to stress. Always discharge capacitors after each process or step. Ground the IC during assembly steps as an antistatic measure, and use similar caution when transporting or storing the IC. Always turn the IC's power supply off before connecting it to or removing it from a jig or fixture during the inspection process.

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